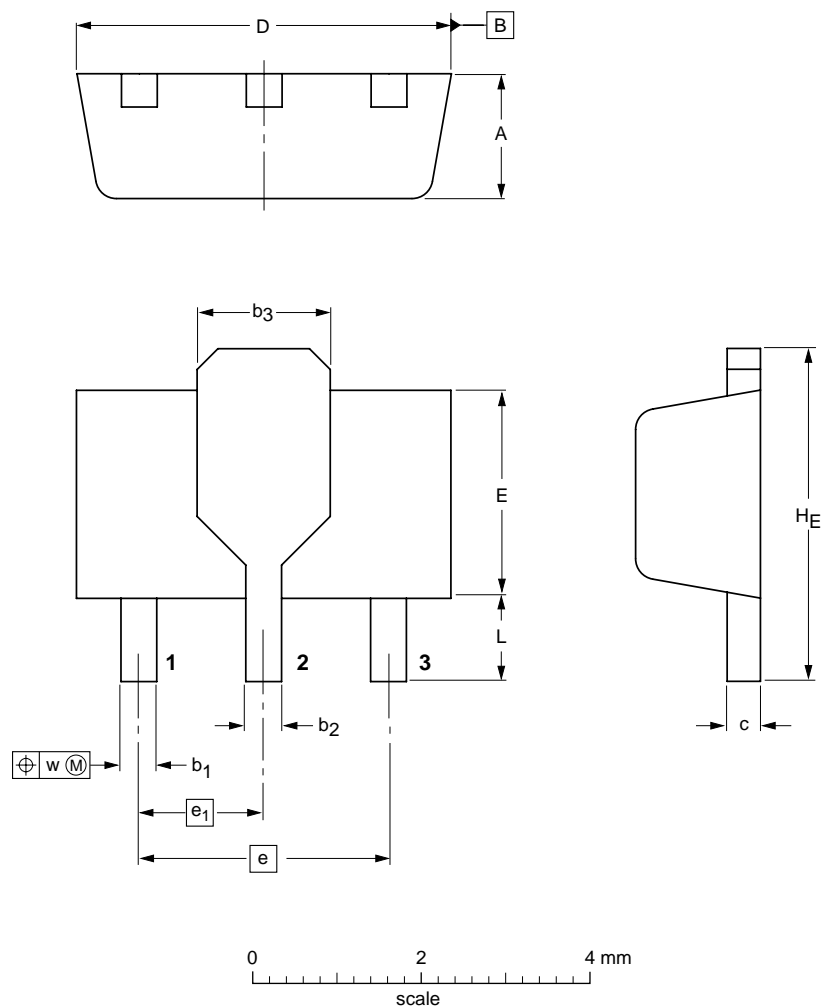


Plastic surface mounted package; collector pad for good heat transfer; 3 leads

SOT89

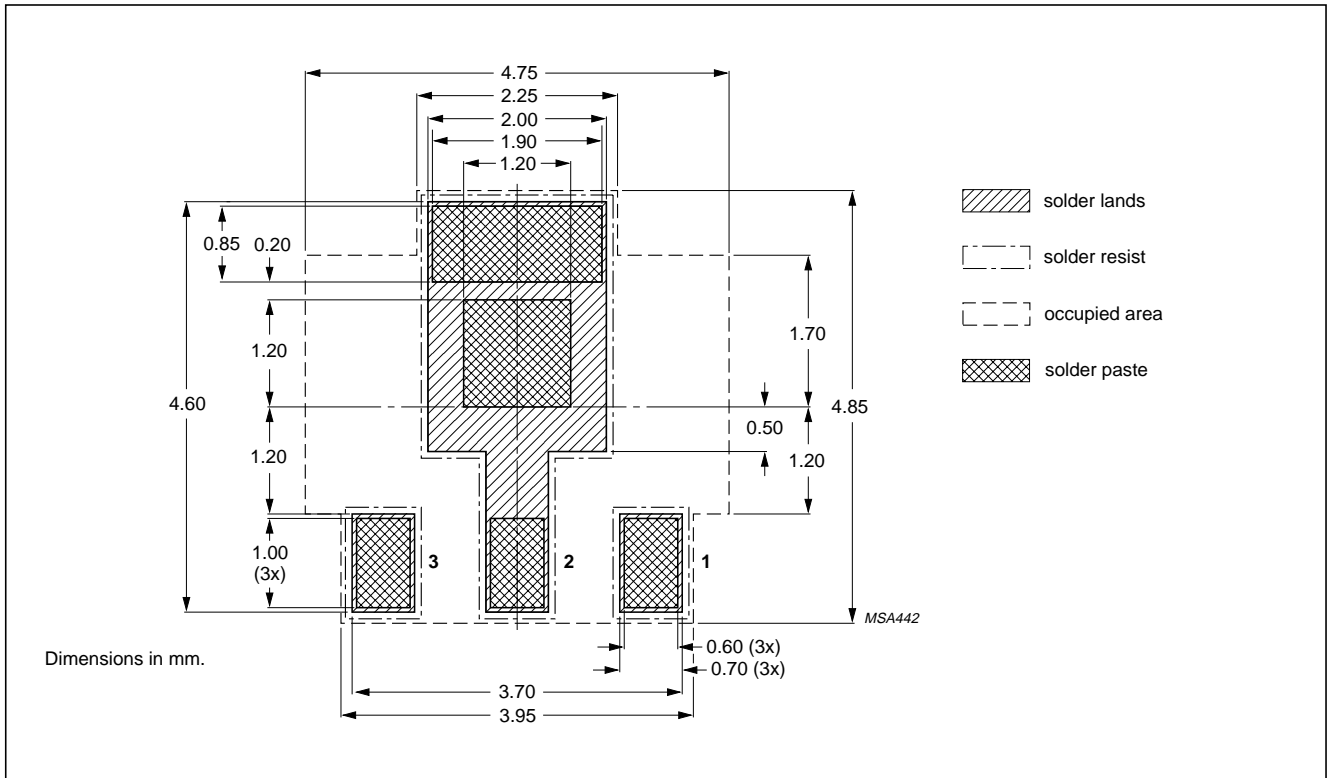


DIMENSIONS (mm are the original dimensions)

UNIT	A	b ₁	b ₂	b ₃	c	D	E	e	e ₁	H _E	L min.	w
mm	1.6 1.4	0.48 0.35	0.53 0.40	1.8 1.4	0.44 0.37	4.6 4.4	2.6 2.4	3.0	1.5	4.25 3.75	0.8	0.13

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	EIAJ			
SOT89		TO-243	SC-62			97-02-28 99-09-13

SOT89 (SC-62) FOOTPRINT (REFLOW SOLDERING)



SOT89 (SC-62) FOOTPRINT (WAFE SOLDERING)

